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April 2015

# FGH40T120SMDL4

## 1200 V, 40 A FS Trench IGBT

### Features

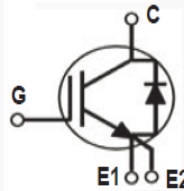
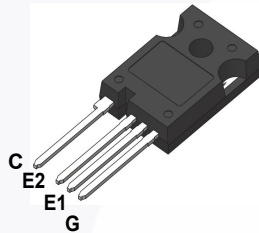
- FS Trench Technology, Positive Temperature Coefficient
- Excellent Switching Performance due to Kelvin Emitter Pin
- Low Saturation Voltage:  $V_{CE(sat)} = 1.8 \text{ V} @ I_C = 40 \text{ A}$
- 100% of the Parts tested for  $I_{LM}(1)$
- High Input Impedance
- RoHS Compliant

### General Description

Using innovative field stop trench IGBT technology, Fairchild®'s new series of field stop trench IGBTs offer the optimum performance for hard switching application such as solar inverter, UPS, welder and PFC applications.

### Applications

- Solar Inverter, Welder, UPS and PFC applications



E1: Kelvin Emitter  
E2: Power Emitter

### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Description	FGH40T120SMDL4	Unit
$V_{CES}$	Collector to Emitter Voltage	1200	V
$V_{GES}$	Gate to Emitter Voltage	$\pm 25$	V
	Transient Gate to Emitter Voltage	$\pm 30$	
$I_C$	Collector Current	@ $T_C = 25^\circ\text{C}$	A
	Collector Current	@ $T_C = 100^\circ\text{C}$	
$I_{LM}(1)$	Clamped Inductive Load Current	@ $T_C = 25^\circ\text{C}$	A
$I_{CM}(2)$	Pulsed Collector Current		A
$I_F$	Diode Continuous Forward Current	@ $T_C = 25^\circ\text{C}$	A
	Diode Continuous Forward Current	@ $T_C = 100^\circ\text{C}$	
$I_{FM}$	Diode Maximum Forward Current		A
$P_D$	Maximum Power Dissipation	@ $T_C = 25^\circ\text{C}$	W
	Maximum Power Dissipation	@ $T_C = 100^\circ\text{C}$	
$T_J$	Operating Junction Temperature	-55 to +175	$^\circ\text{C}$
$T_{stg}$	Storage Temperature Range	-55 to +175	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	FGH40T120SMDL4	Unit
$R_{\theta JC}(\text{IGBT})$	Thermal Resistance, Junction to Case	0.27	$^\circ\text{C}/\text{W}$
$R_{\theta JC}(\text{Diode})$	Thermal Resistance, Junction to Case	0.89	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	40	$^\circ\text{C}/\text{W}$

**Notes:**

1.  $V_{CC} = 600 \text{ V}$ ,  $V_{GE} = 15 \text{ V}$ ,  $I_C = 160 \text{ A}$ ,  $R_G = 20 \Omega$ , inductive load.
2. Limited by  $T_{jmax}$ .

FGH40T120SMDL4 — 1200 V, 40 A Field Stop Trench IGBT

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FGH40T120SMDL4	FGH40T120SMDL4	TO-247 A04	-	-	30

## Electrical Characteristics of the IGBT T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Off Characteristics</b>						
$BV_{CES}$	Collector to Emitter Breakdown Voltage	$V_{GE} = 0\text{ V}, I_C = 250\text{ }\mu\text{A}$	1200	-	-	V
$I_{CES}$	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0\text{ V}$	-	-	250	$\mu\text{A}$
$I_{GES}$	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0\text{ V}$	-	-	$\pm 400$	nA
<b>On Characteristics</b>						
$V_{GE(th)}$	G-E Threshold Voltage	$I_C = 40\text{ mA}, V_{CE} = V_{GE}$	4.9	6.2	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C = 40\text{ A}, V_{GE} = 15\text{ V}, T_C = 25^\circ\text{C}$	-	1.8	2.4	V
		$I_C = 40\text{ A}, V_{GE} = 15\text{ V}, T_C = 175^\circ\text{C}$	-	2.0	-	V
<b>Dynamic Characteristics</b>						
$C_{ies}$	Input Capacitance	$V_{CE} = 30\text{ V}, V_{GE} = 0\text{ V}, f = 1\text{ MHz}$	-	4300	-	pF
$C_{oes}$	Output Capacitance		-	180	-	pF
$C_{res}$	Reverse Transfer Capacitance		-	100	-	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 40\text{ A}, R_G = 10\text{ }\Omega, V_{GE} = 15\text{ V}, \text{Inductive Load}, T_C = 25^\circ\text{C}$	-	44	-	ns
$t_r$	Rise Time		-	42	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	464	-	ns
$t_f$	Fall Time		-	24	-	ns
$E_{on}$	Turn-On Switching Loss		-	2.24	-	mJ
$E_{off}$	Turn-Off Switching Loss		-	1.02	-	mJ
$E_{ts}$	Total Switching Loss		-	3.26	-	mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC} = 600\text{ V}, I_C = 40\text{ A}, R_G = 10\text{ }\Omega, V_{GE} = 15\text{ V}, \text{Inductive Load}, T_C = 175^\circ\text{C}$	-	42	-	ns
$t_r$	Rise Time		-	48	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	518	-	ns
$t_f$	Fall Time		-	24	-	ns
$E_{on}$	Turn-On Switching Loss		-	3.11	-	mJ
$E_{off}$	Turn-Off Switching Loss		-	2.01	-	mJ
$E_{ts}$	Total Switching Loss		-	5.12	-	mJ
$Q_g$	Total Gate Charge	$V_{CE} = 600\text{ V}, I_C = 40\text{ A}, V_{GE} = 15\text{ V}$	-	370	-	nC
$Q_{ge}$	Gate to Emitter Charge		-	23	-	nC
$Q_{gc}$	Gate to Collector Charge		-	210	-	nC

**Electrical Characteristics of the DIODE**  $T_C = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{FM}$	Diode Forward Voltage	$I_F = 40\text{ A}, T_C = 25^\circ\text{C}$	-	3.8	4.8	V
		$I_F = 40\text{ A}, T_C = 175^\circ\text{C}$	-	2.7	-	V
$t_{rr}$	Diode Reverse Recovery Time	$V_R = 600\text{ V}, I_F = 40\text{ A},$ $di_F/dt = 200\text{ A/us}, T_C = 25^\circ\text{C}$	-	65	-	ns
$I_{rr}$	Diode Peak Reverse Recovery Current		-	7.2	-	A
$Q_{rr}$	Diode Reverse Recovery Charge		-	234	-	nC
$t_{rr}$	Diode Reverse Recovery Time	$V_R = 600\text{ V}, I_F = 40\text{ A},$ $di_F/dt = 200\text{ A/us}, T_C = 175^\circ\text{C}$	-	200	-	ns
$I_{rr}$	Diode Peak Reverse Recovery Current		-	18.0	-	A
$Q_{rr}$	Diode Reverse Recovery Charge		-	1800	-	nC

## Typical Performance Characteristics

Figure 1. Typical Output Characteristics

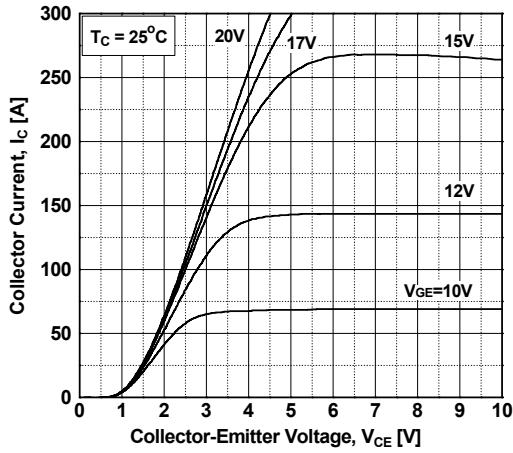


Figure 2. Typical Output Characteristics

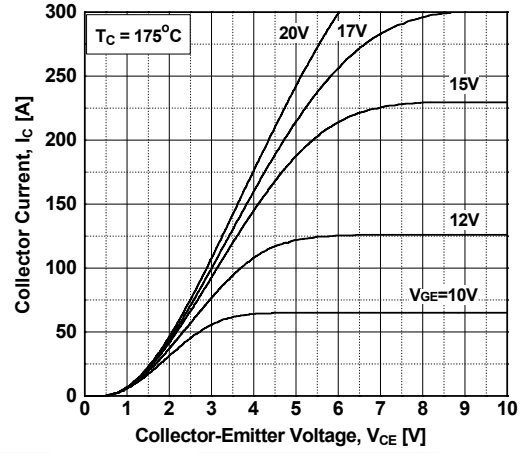


Figure 3. Typical Saturation Voltage Characteristics

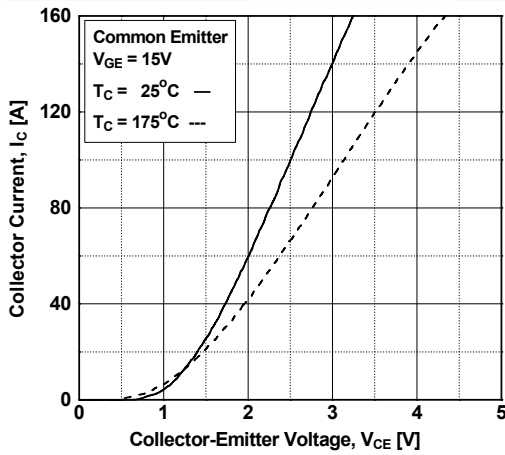


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

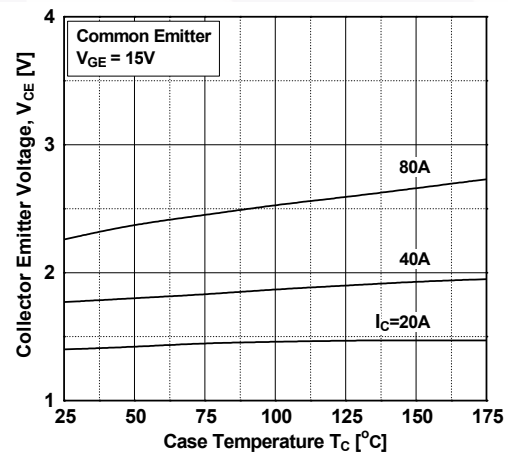


Figure 5. Saturation Voltage vs. Vge

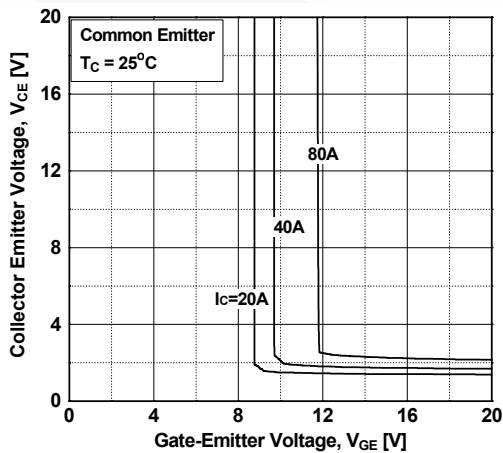
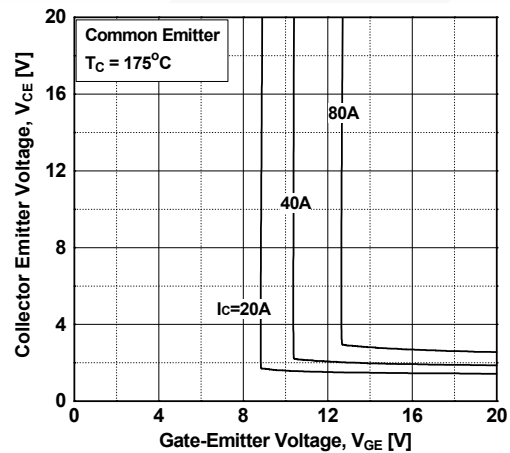


Figure 6. Saturation Voltage vs. Vge



## Typical Performance Characteristics

Figure 7. Capacitance Characteristics

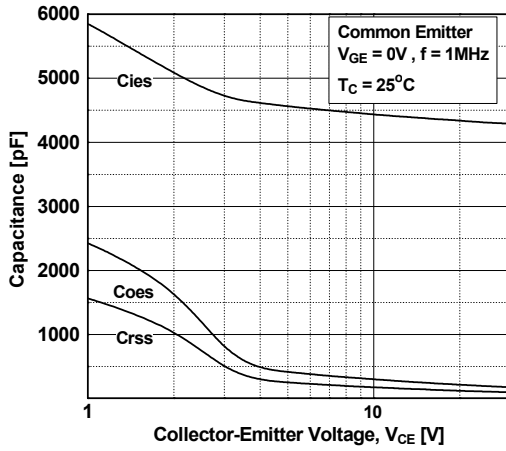


Figure 8. Gate Charge Characteristics

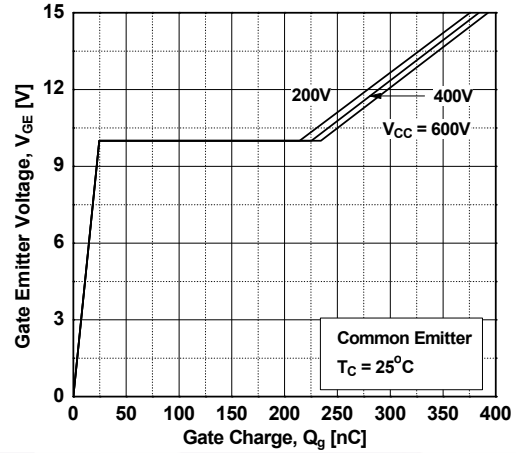


Figure 9. Turn-on Characteristics vs. Gate Resistance

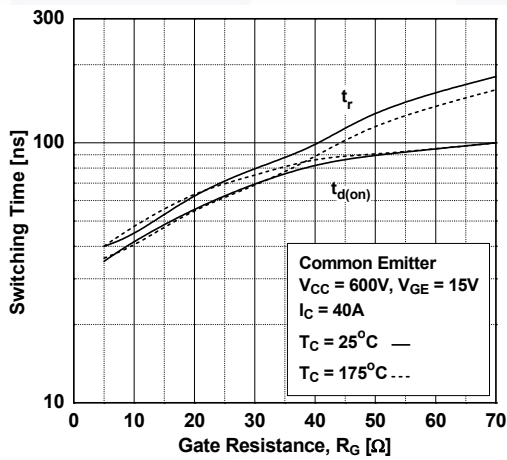


Figure 10. Turn-off Characteristics vs. Gate Resistance

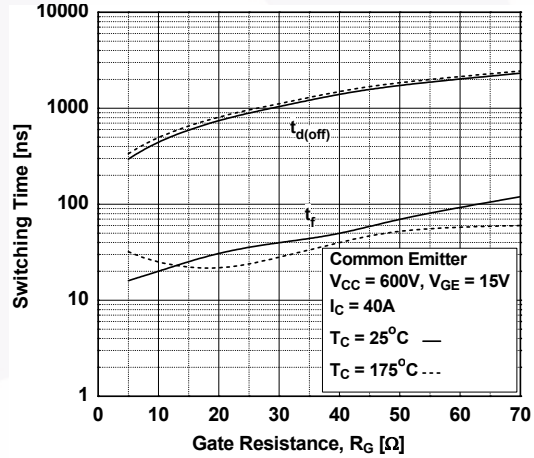


Figure 11. Switching Loss vs. Gate Resistance

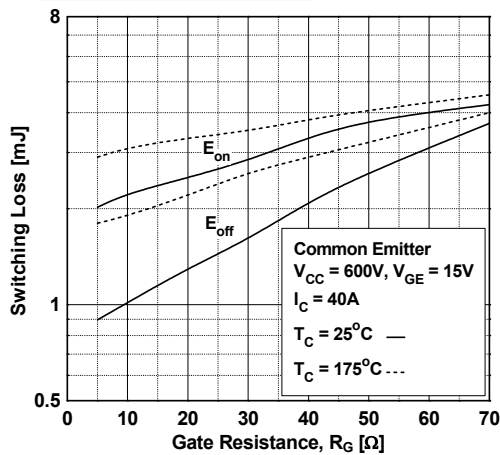
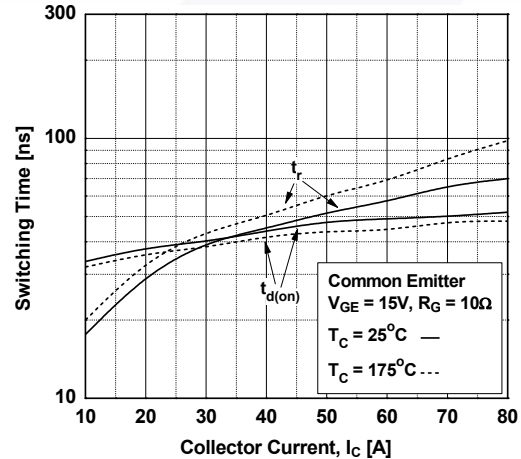
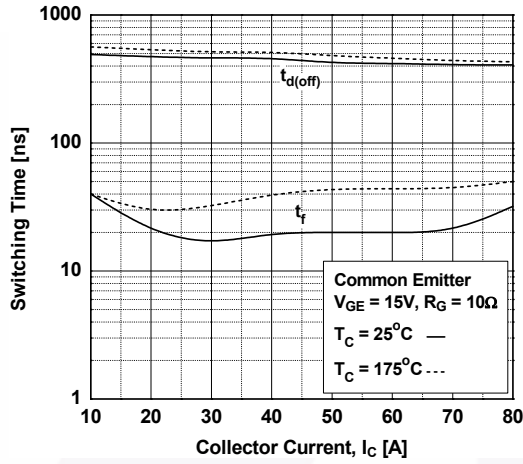


Figure 12. Turn-on Characteristics vs. Collector Current

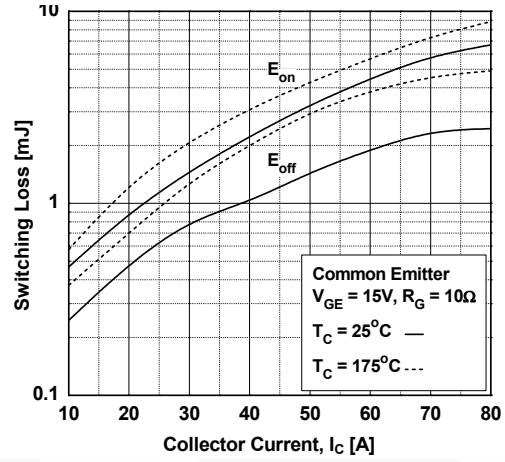


## Typical Performance Characteristics

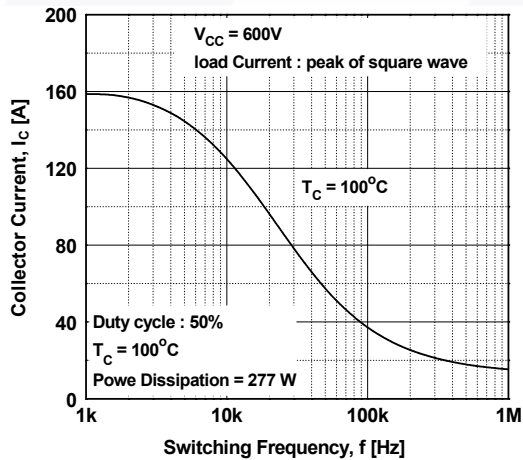
**Figure 13. Turn-off Characteristics vs. Collector Current**



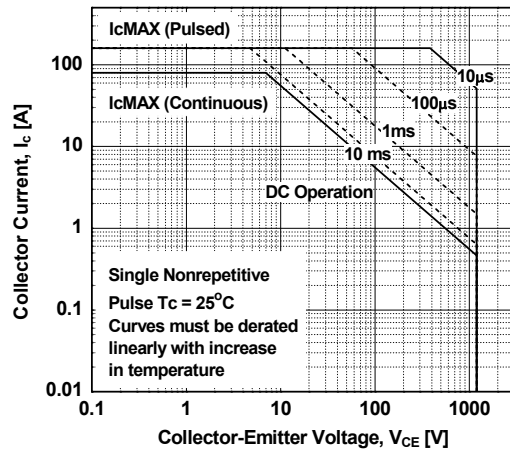
**Figure 14. Switching Loss vs. Collector Current**



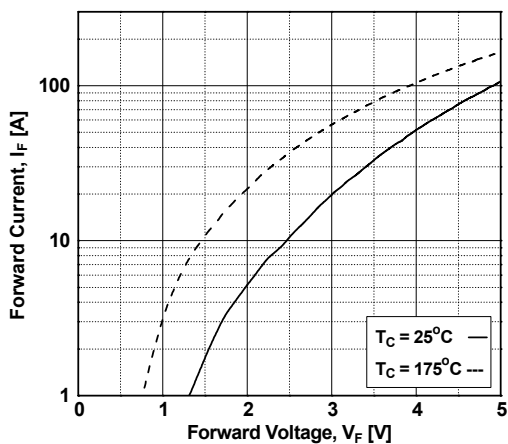
**Figure 15. Load Current vs. Frequency**



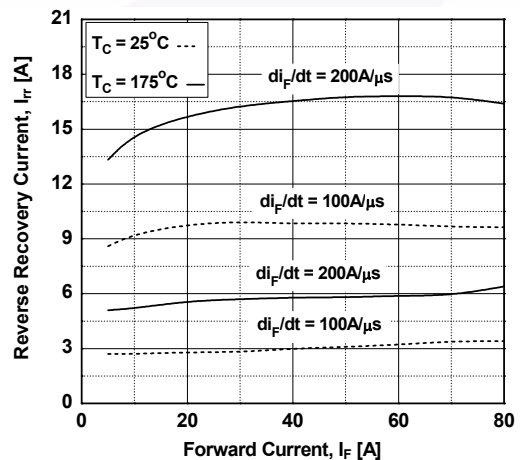
**Figure 16. SOA Characteristics**



**Figure 17. Forward Characteristics**



**Figure 18. Reverse Recovery Current**



### Typical Performance Characteristics

Figure 19. Reverse Recovery Time

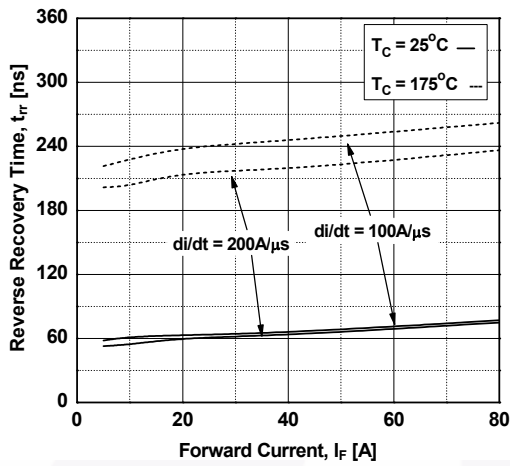


Figure 20. Stored Charge

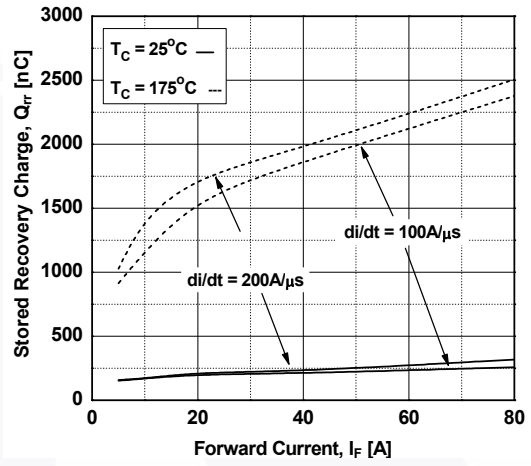


Figure 21. Transient Thermal Impedance of IGBT

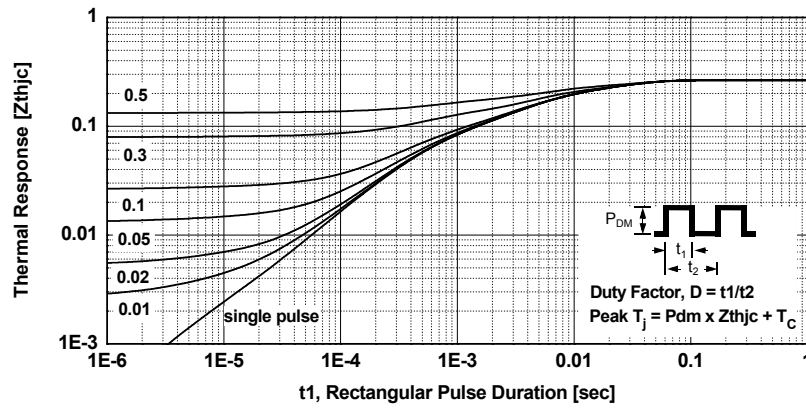
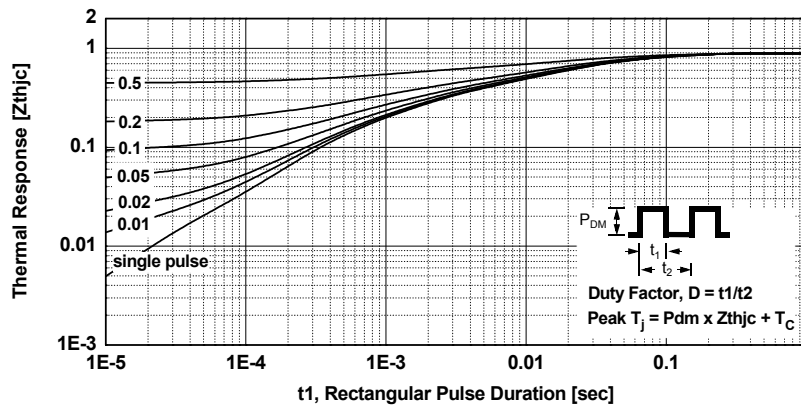
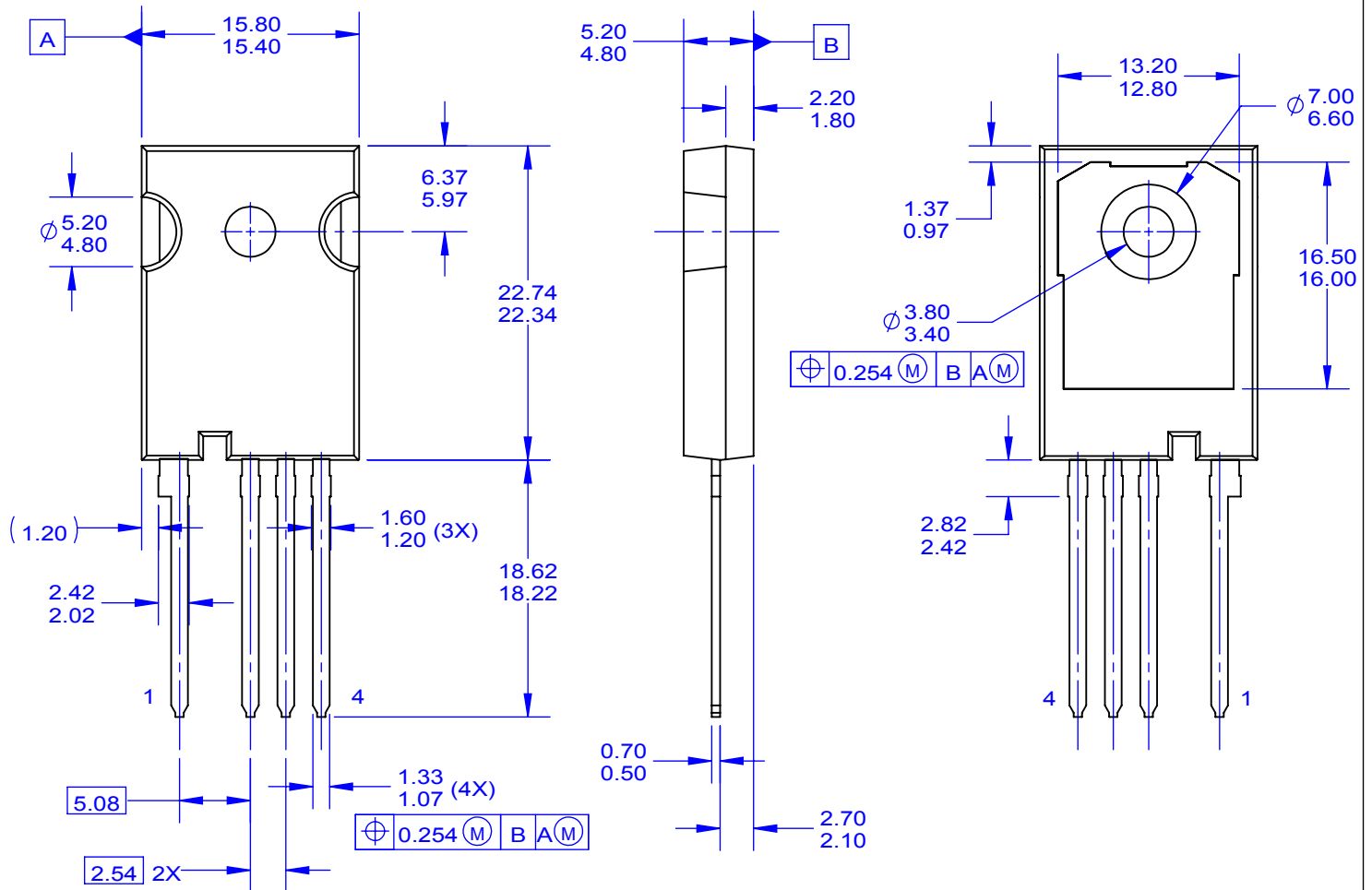


Figure 22. Transient Thermal Impedance of Diode







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No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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Rev. I77

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